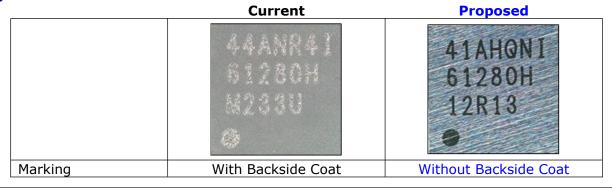
Notification Number:				20240508000.0			Notification Date:		on Date:	May 09, 2024	
Title: Backside Coat rem				noval for select package devices							
Customer Contact: Cha				nge Management team			Dept:	Q	Quality Services		
Change Type:											
	Asse	embly Site			Design			Wafer Bump Material			
	Asse	embly Process			Data Sheet			Wafer Bump Process			
	Assembly Materials					Part number change			Wafer Fab Site		
	Mechanical Specificatio			n		Test Site			Wafer Fab Materials		
	Packing/Shipping/Label			ling		Test Process			Wafer Fab Process		

Notification Details

Description of Change:

This notice is to communicate the removal of backside coat for the devices listed in the product affected section.

Package Device



Reason for Change:

Supply continuity

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

None

Changes to product identification resulting from this notification:

None.

Product Affected:

BCHW12YZS	PTPD1S514-1YZR	TPA2030D1YFFT	TPS61099YFFR
BQ27427YZFR	PTPD1S514-3YZR	TPA2038D1YFFR	TPS61099YFFT
DAN001YZSR	PTPS22914CYFPR	TPA2038D1YFFT	TPS61253AYFFR
INA216A3YFFR	PTPS22925CYPHR	TPD1S514-1YZR	TPS61253AYFFT
LM3644TTYFFR	PTPS6591287YFFR	TPS22914CYFPR	TPS6591287YFFR
LM3648TTYFFR	PTUSB2E112YCGR	TPS22914CYFPT	TUSB2E111YCGR
OPA2376AIYZDR	SN2E111YCGR	TPS22925CYPHR	TUSB2E111YCGT
OPA2376AIYZDT	TPA2011D1YFFR	TPS22925CYPHT	
PGA900AYZSR	TPA2011D1YFFT	TPS610997YFFR	
PGA900AYZST	TPA2030D1YFFR	TPS610997YFFT	

For questions regarding this notice, e-mails can be sent to the Change Management team or your local Field Sales Representative.

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale (www.ti.com/legal/termsofsale.html) or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

Notification# 20240508000.0